



Product Change Notification

Change Notification #: 118623-01
Change Title: Intel® Server System R1208WFQYSR,
Intel® Server System R1304WFTYSR,
PCN 118623-01, Product Design,
Update HSBP and 1100 PSU FW
**Reason for Revision: Updating Change
Description and Products Affected table**
Date of Publication: December 10, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	November 10, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Reason for Revision: Updating Change Description and Products Affected table

Intel is implementing the following changes to the items in table products affected below.

- The Firmware of the 1100W Power Supply Unit will be enhance for better communication with BMC.
- Due to Integrated Circuit (IC) shortage from the supplier, a Programmable System-On-Chip (PSOC) used on the Hot Swap Backplanes needs to be replaced with an alternative component. The new component is identical in function than previous one but differs in form factor. For business continuity, demand fulfillment and to minimize customer impact, an interposer PCB supporting the new component was used. The new component has passed all functional and electrical validation test successfully.

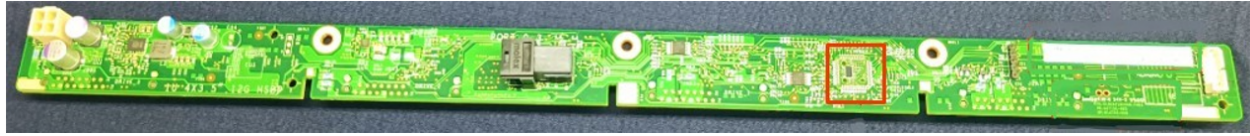
For such reason, products listed in the “Products Affected” table could be delivered to customers with any of two different PBA codes of hot swap backplanes which can be identified as:

MM#: 986048 - G97162-372 or G97162-373
MM#: 986059 - H88382-351 or H88382-352

PBA Code Before - G97162-372



PBA Code After - G97162-373



PBA Code Before - H88382-351



PBA Code After - H88382-352



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA	Backplane PBA
Intel® Server System R1304WFTYSR, Single	R1304WFTYSR	986048	K39979-010	K39979-011	G97162-372 G97162-373
Intel® Server System R1208WFQYSR, Single	R1208WFQYSR	986059	K40302-010	K40302-011	H88382-351 H88382-352

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 26, 2021	00	Originally Published PCN
December 10, 2021	01	Updating Change Description and Products Affected table



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118623-01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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